

## SEMiSTART

Antiparallel thyristors for softstart

## SKKQ 1200

## Preliminary Data

## Features

- Compact design
- Thyristor with amplifying gate
- Pressure contact technology

## Typical Applications

- Soft Starters

## Remarks

- Please note: This module has no soft mold protection around the chip. It is therefore susceptible to environmental influences (dust, humidity, etc.). The humidity test according to IEC60068-2-67 is not passed by this product.
- Recommendation: The devices should be installed in control cabinets of IP54 degree of protection.

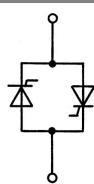
1)  $T_{vjmax}$  up to 150°C is allowable for overload conditions, max. time period for the overload condition is 20s.

## Absolute Maximum Ratings

Symbol	Conditions	Values	Units
$I_{overload}$	$W1C$ ; sin. 180°; 20 sec.; $T_{vjmax.} = 150^\circ\text{C}$ ; $T_{vjstart} = 40^\circ\text{C}$	1225	A
$I_{TSM}$	$T_{vj} = 25^\circ\text{C}$ ; 10 ms	9500	A
	$T_{vj} = 125^\circ\text{C}$ ; 10 ms	8000	A
$I^2t$	$T_{vj} = 25^\circ\text{C}$ ; 8,3 ... 10 ms	451000	A·s
	$T_{vj} = 125^\circ\text{C}$ ; 8,3 ... 10 ms	320000	A·s
SKKQ 1200/14			
$V_{RSM}$		1500	V
$V_{RRM}, V_{DRM}$		1400	V
SKKQ 1200/18			
$V_{RSM}$		1900	V
$V_{RRM}, V_{DRM}$		1800	V
$T_{vj}$		-40 ... +125 <sup>1)</sup>	°C
$T_{stg}$		-40 ... +125	°C

## Characteristics

Symbol	Conditions	min.	typ.	max.	Units	
$V_T$	$T_{vj} = 25^\circ\text{C}$ ; $I_T = 1500 \text{ A}$			1,65	V	
$V_{T(TO)}$	$T_{vj} = 125^\circ\text{C}$			0,9	V	
$r_T$	$T_{vj} = 125^\circ\text{C}$			0,5	mΩ	
$I_{DD}; I_{RD}$	$T_{vj} = 125^\circ\text{C}$ ; $V_{RD} = V_{RRM}$ ; per module			72	mA	
$t_{gd}$	$T_{vj} = 25^\circ\text{C}$ ; $I_G = 1\text{A}$ ; $di_G/dt = 1\text{A}/\mu\text{s}$		1		μs	
$t_{gr}$	$V_D = 0,67 * V_{DRM}$		2		μs	
$(dv/dt)_{cr}$	$T_{vj} = 125^\circ\text{C}$			1000	V/μs	
$(di/dt)_{cr}$	$T_{vj} = 125^\circ\text{C}$ ; $f = 50 \dots 60 \text{ Hz}$			200	A/μs	
$t_q$	$T_{vj} = 125^\circ\text{C}$			150	μs	
$I_H$	$T_{vj} = 25^\circ\text{C}$			150	mA	
$I_L$	$T_{vj} = 25^\circ\text{C}$ ; $R_G = 33 \Omega$			500	mA	
				300	2000	mA
$V_{GT}$	$T_{vj} = 25^\circ\text{C}$ ; d.c.		3		V	
$I_{GT}$	$T_{vj} = 25^\circ\text{C}$ ; d.c.	200			mA	
$V_{GD}$	$T_{vj} = 125^\circ\text{C}$ ; d.c.			0,25	V	
$I_{GD}$	$T_{vj} = 125^\circ\text{C}$ ; d.c.			10	mA	
$R_{th(j-s)}$	cont.; per thyristor			0,066	K/W	
$M_t$				5 ± 15%	Nm	
$m$	approx.			1200	g	
Case				C 12		



W1C

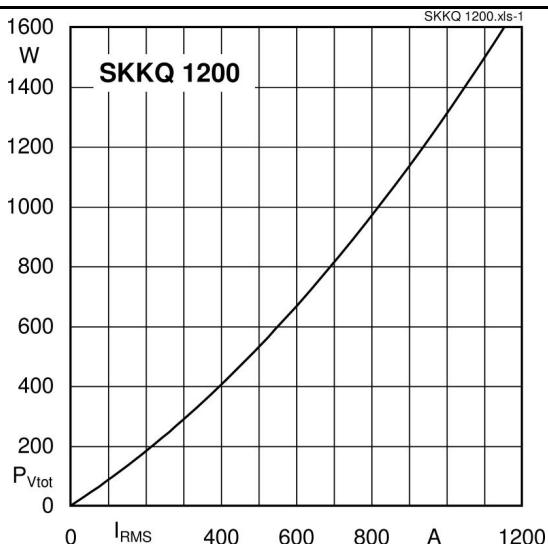


Fig. 1 Power dissipation per module vs. rms current

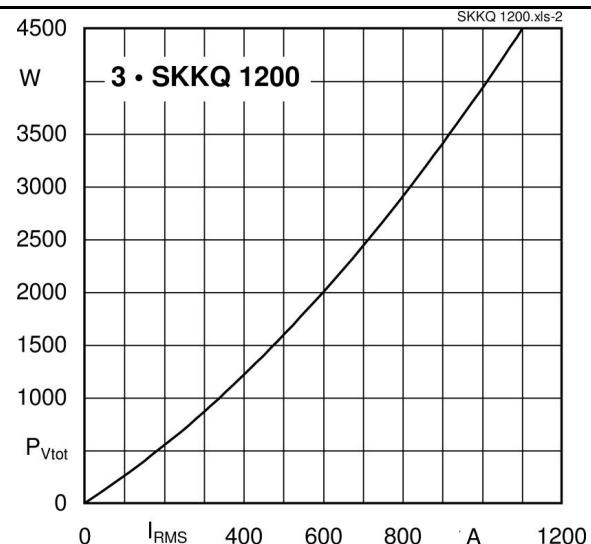


Fig. 2 Power dissipation of three modules vs. rms current

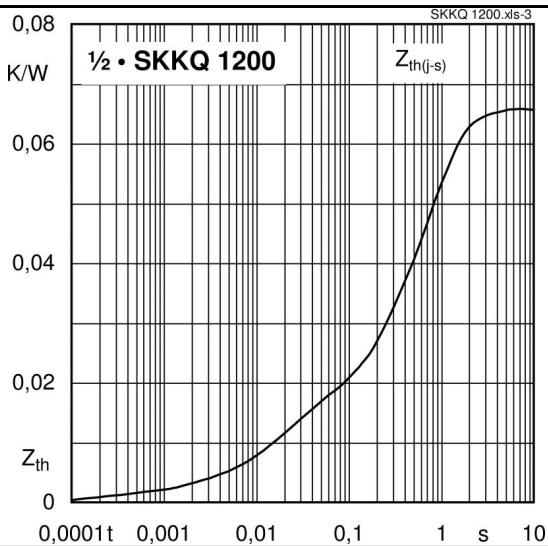
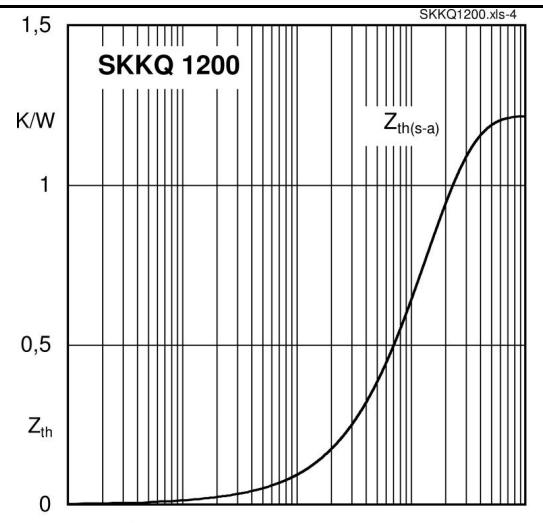
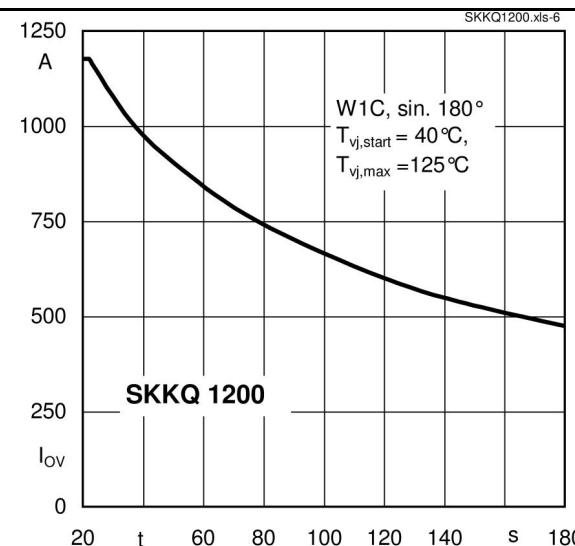
Fig. 3 Transient thermal impedance  $Z_{th(j-s)}$  vs. timeFig. 4 Typ. transient thermal impedance  $Z_{th(s-a)}$  vs. time (natural cooling)

Fig. 6 Typ. overload current vs. time (natural cooling)

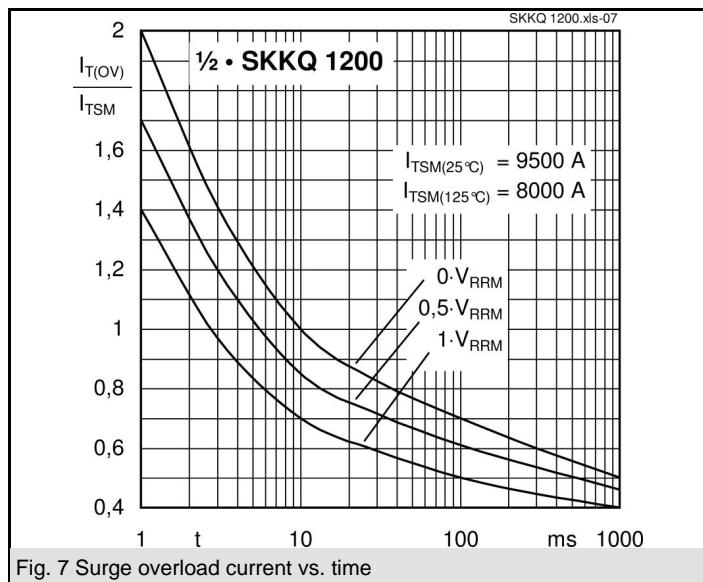


Fig. 7 Surge overload current vs. time

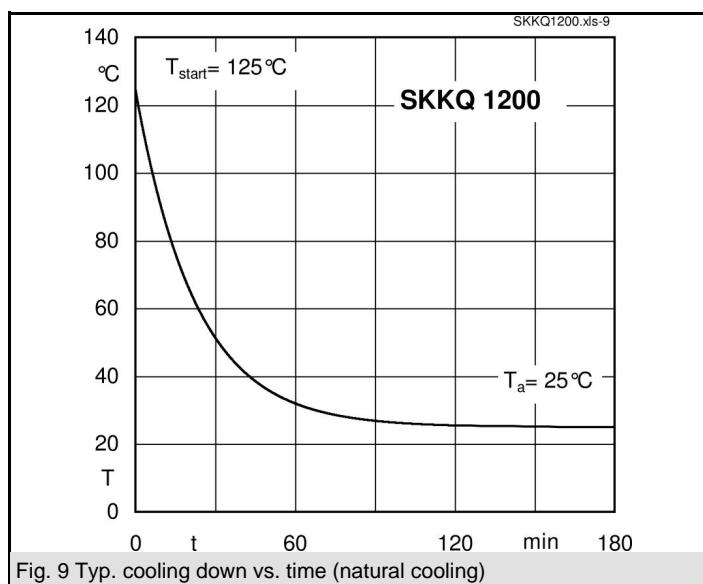
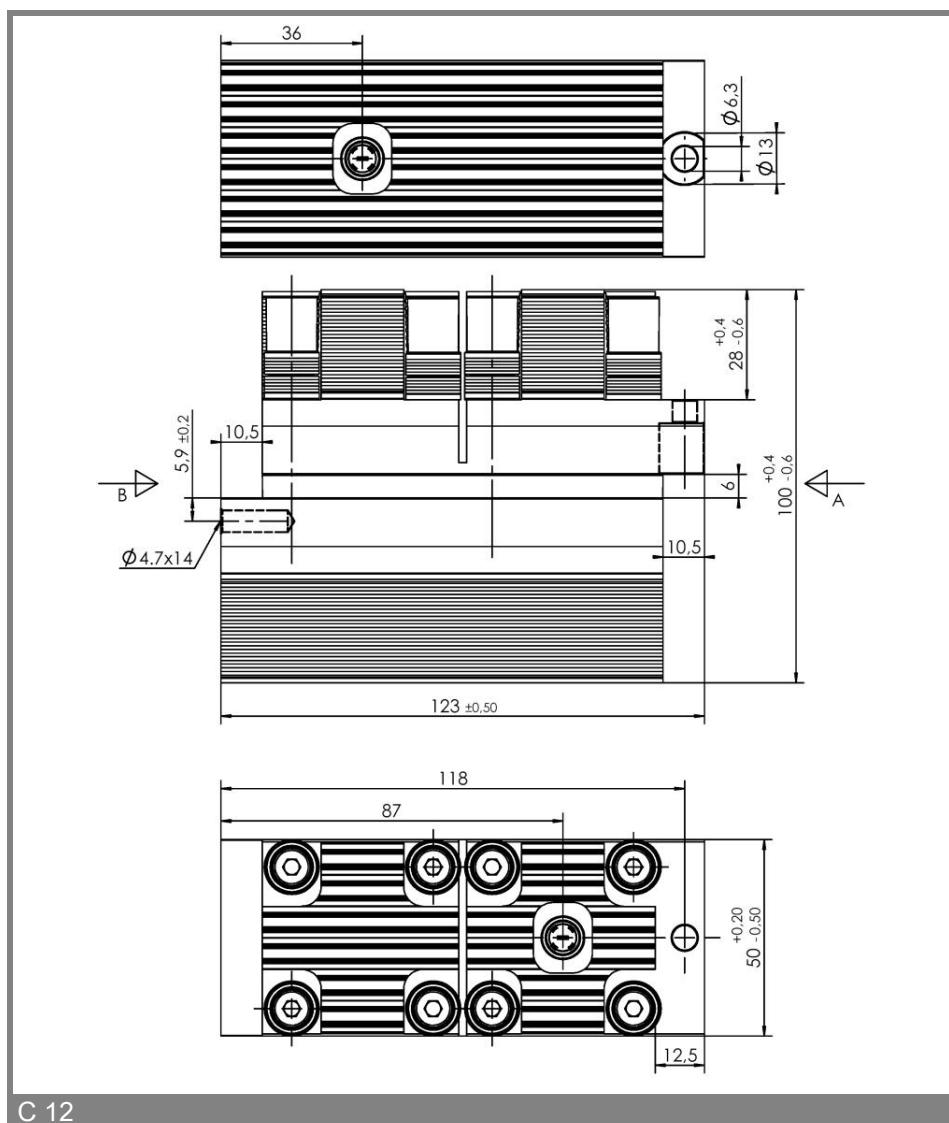


Fig. 9 Typ. cooling down vs. time (natural cooling)



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